

N109 W13300 ELLSWORTH DRIVE GERMANTOWN, WI 53022
262-253-5900 FAX 262-253-5919

DESCRIPTION:

ResinLab® EP1215RCLV Green is a two-part unfilled epoxy structural adhesive designed for bonding applications requiring high strength and good impact resistance. It cures completely at room temperature to a tough, flexible to semi-rigid polymer depending upon the mix ratio employed. It has good wetting and adhesion to most surfaces and has a free-flowing viscosity. It has very good resistance to water, acids and bases, and most organic solvents. This version was designed to be compliant to the REACH regulation, and as of the date of this document it contains no raw materials listed on the ECHA Substances of Very High Concern list. This formula also complies with the ROHS 3 Directive (EU) 2015/863.

EP1215RCLV Green was formulated to allow users to vary mix ratio to achieve desired hardness and flexibility. It can be mixed anywhere from an A/B ratio of 2 to 1 to 1 to 2 by weight or volume. EP1215RCLV Green will normally reach full cure at room temperature within 24 – 48 hours. Cure time can be accelerated by the application of heat. Times and temperatures from 2 hours at 65 °C to 10 minutes at 100 °C are typical for most applications. Time to heat substrate must be taken into account. Cooler temperatures will also extend work time and increase cure times.

TYPICAL PROPERTIES:

All properties given are at 25 °C unless otherwise noted.

Property:	Value: 1A:1B	Value: 2A:1B	Value: 1A:2B	Test Method or Source:
Color	Medium Green	Light Green	Dark Green	Visual
Mix Ratio	Part A to Part B	Part A to Part B	Part A to Part B	Calculated
By weight	1.19 to 1	2.39 to 1	0.6 to 2	
By volume	1 to 1	2 to 1	1 to 2	
Cure Schedule	24-48 hours @ 25 °C 2 hrs @ 65 °C 10 min @ 100 °C	24-48 hours @ 25 °C 2 hrs @ 65 °C 10 min @ 100 °C	24-48 hours @ 25 °C 2 hrs @ 65 °C 10 min @ 100 °C	
Viscosity – A	11,500 cps @1/s	11,500 cps @1/s	11,500 cps @1/s	TA HR20 Rheometer
Viscosity – B	6,000 cps @1/s	6,000 cps @1/s	6,000 cps @1/s	25mm parallel plate
Viscosity - Mixed	8,000 cps @1/s	10,900 cps @1/s	6,500 cps @1/s	
SG – Part A	1.16	1.16	1.16	Calculated
SG – Part B	0.98	0.98	0.98	
SG – Mixed	1.07	1.10	1.04	
Pot Life, defined as the time it takes for initial mixed viscosity to double	78 minutes	73 minutes	63 minutes	TA HR20 Rheometer 25mm parallel plate
Gel Time	4 hr, 45 min/100cc sample/Hot Pot	4 hr, 40 min/100cc sample/Stable Temp	4 hr, 20 min/ 100cc sample/Hot Pot	455300005339/Gardco Stable Temp & Hot Pot Gel Timer
Hardness	80 Shore D	80 Shore D	65 Shore D	455300006287/ASTM D2240
Glass Transition Temperature/Tg	57 °C	87 °C	21 °C	453560822409 by DSC
Water Absorption	0.10%	0.08%	0.65%	457561824543/ASTM D570

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Property:	Value: 1A:1B	Value: 2A:1B	Value: 1A:2B	Test Method or Source:
Peak Exotherm 40 mL sample	29 °C after 2hr and 6 minutes	28.5 °C after 1hr and 48 minutes	25.5 °C after 1hr and 44 minutes	455300005593 by Type K thermocouple
Coefficient of Thermal Expansion by TMA	78 ppm/ °C below Tg 208 ppm/ °C above Tg	70 ppm/ °C below Tg 197 ppm/ °C above Tg	83 ppm/ °C below Tg 218 ppm/ °C above Tg	455300005340/ASTM E831, TMA, 5 °C/min
Tensile Properties:				4535601224470/ASTM
Strength	7,000 psi	8,500 psi	1,100 psi	D638
Elongation	4-5%	3-4%	55%	
Modulus	300,000 psi	370,000 psi	29,500 psi	
Lap Shear Strength 0.010" bond line Al to Al	1,800 psi	1,100 psi	2,000 psi	4535601224468/ASTM D1002
Compressive Properties:				4535601224467/ASTM
Yield Strength	9,700 psi	14,500 psi	18,000 psi	D695
Offset (0.2%) Yield Str.	8,000 psi	9,500 psi	38,000 psi	
Compressive Strength	23,000 psi	21,500 psi	33,500 psi	
Modulus	168,000 psi	140,000 psi	310,000 psi	
Operating Temperature Range	-40 to 150 °C**	-40 to 150 °C**	-40 to 150 °C**	
Relative Thermal Index (RTI)	90 °C **	90 °C **	90 °C **	UL746B, Table 7.1 Generic Value Based on Composition

* Asterisk denotes values considered typical to associated resin systems or extrapolated from other test results.

** Operating Temperature Range is based on average design requirements and is not intended as a guarantee of suitability for all applications operating at that temperature.

*** This TDS contains values that have been updated. The values reported in this technical data sheet are typical values of the product and are highly dependent on test conditions and methodology. We actively seek the most precise and accurate ways to measure and interpret performance of our products, and to update estimated values with measured values. The formula has not been revised or changed in any way. Although the values on paper have changed, you can expect the same performance of the product.

INSTRUCTIONS:

1. Bring both components to room temperature prior to mixing. When bonding parts, surfaces should be clean and dry.
2. Cartridge format: Mixer should be attached keeping the cartridge vertical and any air pocket purged this way. After the mixer contains material, the mixer tip can be dropped to dispense pre-bleed amount. Attach a new static mixer with each cartridge, then pre-bleed the first 3 inches of dispensed material or until a uniform color is obtained. Maintain adequate velocity during dispensing to ensure complete mixing.

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3. Bulk format: weigh and mix parts A and B accurately and thoroughly, scraping sides of container often. Do not pour from mixing container, transfer to a new container as residual unmixed material may cause a tacky spot on the surface of the casting. Maintain adequate velocity during dispensing to ensure complete mixing.
4. Allow to cure undisturbed until product is fully gelled or tack-free to the touch.
5. Clean up uncured resin with suitable organic solvent such as MEK, acetone or other organic solvent.

SHELF LIFE AND STORAGE: 12 months at 25 °C
Specialty packaging may be less.

Many epoxy resin systems are prone to crystallization as epoxy resin is a super-cooled fluid. This condition may give the product a gritty or grainy appearance (or hazy in clear products). Products in this state will not usually cure to normal and expected properties. In extreme cases it may appear solid and cured. Fluctuating temperatures (within 5 to 50 °C) aggravate this phenomenon. Heating the individual component to 50 to 60 °C while stirring can usually restore products to original state. Storage at 25 +/- 10 °C is optimum for most products.